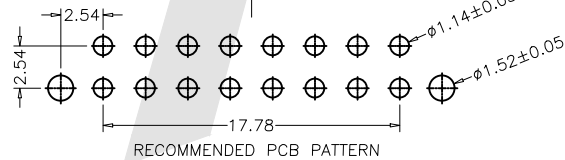
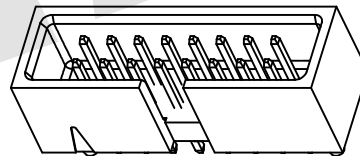
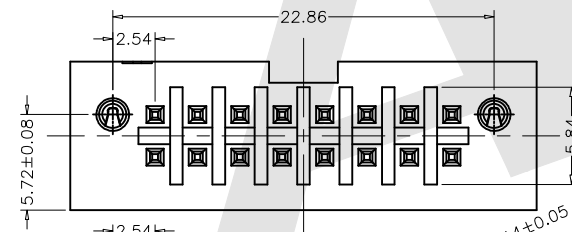
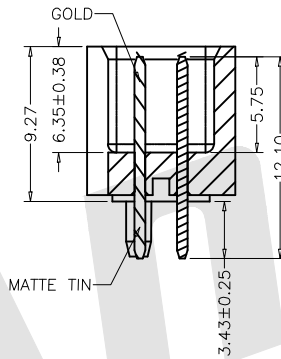
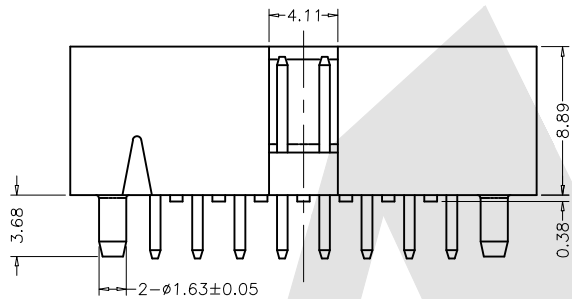
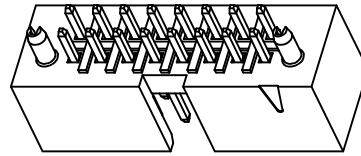
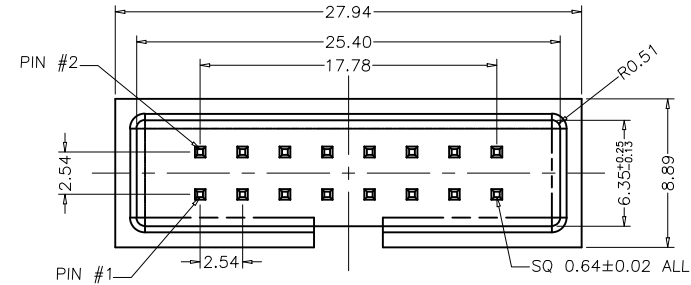


HSF



ROHS



SPECIFICATION

Current Rating: 3.0Amp
 Insulation Resistance: 1000MΩ min
 Contact Resistance: 20mΩ max
 Withstand Voltage: 500V AC/DC
 Operating Temperature: -40° C to +105° C
 Material: PA46+30%GF UL94V-0 BIEGE
 Contact Material: Brass
 Contact Plating:
 Contact area with gold plated 0.8u,
 solder tail area with tin plated 80-100u,
 over nickel plated 80u.

Ordering Code:

BHDS10 - 16 - X - X - X - X
 ① ② ③ ④ ⑤ ⑥

- ① Series No:
04 06 08 10 12 14 16
18 20 24 26 30 44 50
56 60 64
- ② No. of Contacts
- ③ Contact Plating:
G0:Gold flash S0:Selective
G1:3U" Gold S1:Selective 3u"
G2:5u" Gold S2:Selective 5u"
G3:10u" Gold S3:Selective 10u"
G4:15u" Gold S4:Selective 15u"
G5:30u" Gold S5:Selective 30u"
SN: Tin
- ④ Color Insulator
B:Black
U:Blue
G:Gray
- ⑤ Insulator Material
A:PBT
B:PA6T
D:PA46
E:PA9T
- ⑥ Packing
A:Tray
B:Bag
T:Tube
U:Tube+CAP
R:Tape&Reel
W:Tape&Reel+CAP

Unless Otherwise specified tolerance
 X. ±0.35 X.XX: ±0.20
 X.X: ±0.25 X.XXX: ±0.15

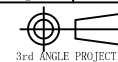
SCALE: As Shown UNIT: mm
 DRAW ZLA DATE 25/04/2022
 CHECK BobYang DATE 25/04/2022

Antenk ANTEK ELECTRONICS CO., LTD
 Http://www.antenk.com
 E-mail:sales@antenk.com

TITLE: 2.54mm Box Header Molex Type 180°
 H=8.89

DRAWING NO: BHDS10-16-X-X-X-X

PRODUCT NO: BHDS10-16-X-X-X-X



REV	DESCRIPTION			DATE
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